

TA50R0-100-25X Features:

• Flange Mount

RoHS Compliant

• Customer Defined Testing Available

· High Rated Power

• Covered Resistor Element

• ±5% Resistor Tolerance

TA50R0-100-25X Parameters:

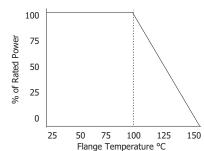
Operating Frequency: DC - 3.5GHz
Rated Power: 100W*

Return Loss (Typical)**: 26dB or Better (DC - 2GHz) 20dB or Better (>2GHz - 3.5GHz)

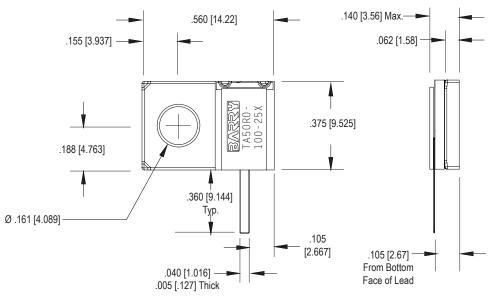
Operating Temperature: -55 to +150°C



TA50R0-100-25X Power Derating Curve



TA50R0-100-25X Dimensions:





Dimensions in inches [mm]
Tolerance is ± 0.010 [0.254]
unless otherwise stated

- * Rating based on ≤100°C constant flange temperature ** In a matched, continious 50Ω system with proper workmanship.
- workmanship
 *** Other values and tolerances available. Contact factory.

Ordering Information:



Barry Industries reserves the right to change part number and/or process without notification.



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TA50R0-100-25X Reliability Data:

Parameter:	Test Condition:	Results:
Short Time Overload	Apply 1.1x Rated Power for 5 Seconds.	≤ 5.0% Resistance Shift
Rated Load Life	Apply 1/2 Power Under 40°C ±2°C 90 Minutes on/ 30 Minutes off. Repeat for 100 hours	≤ 5.0% Resistance Shift
Moisture Resistance	MIL-PRF-55342 para.4.8.9 95% RH, 25°C - 65°C	≤ 5.0% Resistance Shift
Resistance to Soldering Heat (Lead)	MIL-STD-202 Method 210 Test Condition "A"	≤ 5.0% Resistance Shift
Resistance to Soldering Heat (Assembly)	MIL-STD-202 Method 210 Test Condition "J"	≤ 5.0% Resistance Shift
Terminal Strength	MIL-STD-202 Method 211 Test Condition "A" 3lbs. Test Condition "B" 5 bends	No Significant Abnormality (Visual)
Solderability (Lead only)	MIL-STD-202 Method 208 Test C	>95% Covered
High Temperature Storage	125°C ±2°C for 500 Hours	1.) ≤ 5.0% Resistance Shift2.) No Significant Abnormality (Visual)
Thermal Shock	-5°C to +150°C 30 Minutes Dwell, 5 Cycles	1.) ≤ 5.0% Resistance Shift2.) No Significant Abnormality (Visual)

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